Product Details for 146897



146897

Active

.4mm, .5mm, .6mm, .8mm, 1mm, Fine Pitch, Surface Mount, Stacking Bd Connectors

5 of 6 RoHS/ELV Compliant (Find RoHS Compliant Alternates/Compliance Statement)

Product Highlights:

- Family Name = Free Height
- 1.00 mm Centerline
- Number of Positions = 84
- In -Line Contact Layout

View all Features

Quick Links

Check Pricing & Availability Search for Tooling View Mating Products (6) Product Feature Selector Contact Us About This Product

Documentation & Additional Information

Product Drawings:

PLUG ASSY, W/VACUUM COVER, 1.0mm FH(IEEE 1386) CONNECTO (PDF, English)

Catalog Pages/Data Sheets:

None Available

Product Specifications:

? None Available

Application Specifications:

? None Available

Instruction Sheets:

? None Available

CAD Files: (CAD Format & Compression Information

- 2 3D Model (STEP, Version C)
- ? 3D Model (IGES, Version C)
- ? 2D Drawing (DXF, Version C)

Additional Information:

Product Line Information

Additional Product Images:

? Product Photo

Related Products:

? Tooling

-to-Bd

? Mating Products (6)

List all Documents

Product Features (Please use the Product Drawing for all design activity)

Product Type Features:

- ? Product Type = Plug
- ? Number of Positions
- ? PCB Mount Angle = Vertical
- ? Keved = No
- ? Comment = IEEE 1386 Mezzanine Connector.

Body Related Features:

- ? Centerline (mm [in]) = 1.00 [0.039]
- Poard -to -Board Stack Height (mm [in]) [0.315]
- ? Locating Posts = With
- ? Vacuum Cover = With
- ? Number of Rows = Dual

Contact Related Features:

- ? Family Name = Free Height
- ? Contact Layout = In -Line
- ? Contact Material = Copper Alloy
- Contact Mating Area Plating = Gold (30)
- ? Contact Termination Area Plating = Tin -Lead over Nickel

Housing Related Features:

- ? Housing Color = Black
- ? Housing Material = LCP
- ? Housing Flammability Rating = UL 94V
- ? Housing Material Temperature = High

Industry Standards:

? RoHS/ELV Compliance = ELV compliant, 5 of 6 Compliant

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¿ <u>Lead Free Solder Processes</u> = Wave solder capable to 240°C, Wave solder capable to 260° C, Wave solder capable to 265°C, Reflow solder capable to 245°C, Reflow solder capable to 260°C, Pin -in-Paste capable to 245°C, Pin in-Paste capable to 260°C

Packaging Related Features:

? Packaging Method = Tape & Reel

Other:

? Brand = AMP